

TECHNICAL DATA SHEET



Epoxease Mold Release Bulk/Liquid 40601HB, 40605HB, 40655HB

Product Description

EpoxEase is a synthetic wax-based, non-silicone release. It is formulated to prevent the sticking commonly seen when using all-purpose release agents on epoxies, maximizing your productivity. Ideal for use on epoxy, polyester and phenolic resins and most often utilized in encapsulating and potting applications.

Applications

Mold Release

Unit Package Description

1, 5 and 55-gallon containers

Generic Description

Mold Release for Epoxy Resins

Approx. Net Weight Fill per Gal.

9 pounds

Net Weight Fill

1 - 55 gallons

Appearance

Light-brown Oily Wax

Odor

Mild, Petroleum-like

Flash Point F

None

Flash Point C

None

Base Type

Wax

Evaporation Rate

Fast

HMIS Rating

2, 1, 0, B

DOT Proper Shipping Name

Not Regulated

VOC % (Federal)

91

VOC g/L (Federal)

981.38

VOC lbs./Gal (Federal)

8.19

Removal

Remove with organic or hydrocarbon solvents

Units Per Case

1

Case Weight (lbs)

Various

Working Temperature F

32 to 450 degrees

Working Temperature C

0 to 232 degrees

Specific Gravity

1.19